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Parameter		Symbol	Тур Мах		Units					
Maximum Junction-to-Ambient ^A	t ≤ 10s	D	33	40	°C/W					
Maximum Junction-to-Ambient ^A	Steady-State	ιν _θ ja	62	75	°C/W					
Maximum Junction-to-Lead ^C	Steady-State	$R_{ ext{ heta}JL}$	18	24	°C/W					

Electrical Characteristics (T J=25°C unless otherwise noted)

Symbol	Parameter Conditions			Min	Тур	Max	Units
STATIC P	ARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I_D =-250µA, V_{GS} =0V		-30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-24V, V _{GS} =0V	T _{.I} =55°C			-1 -5	μA
I _{GSS}	Gate-Body leakage current	Gate-Body leakage current V _{DS} =0V, V _{GS} =±20V				±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} I _D =-250μA	V _{DS} =V _{GS} I _D =-250μA			-2.5	V
I _{D(ON)}	Dn state drain current V _{GS} =-10V, V _{DS} =-5V			-30			Α
R _{DS(ON)} S	Static Drain-Source On-Resistance	V _{GS} =-10V, I _D =-6.5A			38	46	mΩ
			TJ=125°C		53	68	
		V _{GS} =-4.5V, I _D =-5A	•		58	72	mΩ
g _{FS}	Forward Transconductance V _{DS} =-5V, I _D =-6.5A				11		S
V _{SD}	Diode Forward Voltage I _S =-1A,V _{GS} =0V				-0.78	-1	V
Is Maximum Body-Diode Continuous Current						-3.5	А
DYNAMIC	PARAMETERS				•		
C _{iss}	Input Capacitance				668	830	pF
C _{oss}	Output Capacitance	V _{GS} =0V, V _{DS} =-15V, f=1MHz			126		pF
C _{rss}	Reverse Transfer Capacitance				92		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			6	9	Ω
SWITCHI	NG PARAMETERS	•			•		
Q _g (10V)	Total Gate Charge (10V)				12.7	16	nC
Q _g (4.5V)	Total Gate Charge (4.5V)	–V _{GS} =-10V, V _{DS} =-15V, I _D =-6.5A			6.4		nC
Q _{gs}	Gate Source Charge				2		nC
Q _{gd}	Gate Drain Charge				4		nC
t _{D(on)}	Turn-On DelayTime				7.7		ns
t _r	Turn-On Rise Time	V _{GS} =-10V, V _{DS} =-15V,		6.8		ns	
t _{D(off)}	Turn-Off DelayTime	R _{GEN} =3Ω			20		ns
t _f	Turn-Off Fall Time				10		ns
t _{rr}	Body Diode Reverse Recovery Time I _F =-6.5A, dI/dt=100A/µs			22	30	ns	
Q _{rr}	Body Diode Reverse Recovery Charge I _F =-6.5A, dl/dt=100A/µs			15		nC	

A: The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^{\circ}C$. The value in any a given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\rm 0JA}$ is the sum of the thermal impedence from junction to lead R $_{\rm 0JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using < 300μ s pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25$ °C. The SOA curve provides a single pulse rating.

Rev0 Sept 2006

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)